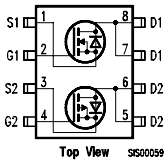
SIPMOS® Small-Signal-Transistor

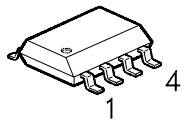
Features

- Dual N- and P -Channel
- Enhancement mode
- Logic Level
- Avalanche rated
- d*v*/d*t* rated

Product Summary

		N	P	
Drain source voltage	V_{DS}	30	-30	V
Drain-Source on-state resistance	$R_{DS(on)}$	0.11	0.25	Ω
Continuous drain current	I_D	3.4	-2.3	A





VPS05121

Type	Package	Ordering Code
BSO 315 C	SO 8	Q67041-S4014

Maximum Ratings,at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Value		Unit
		N	P	
Continuous drain current	I_D			A
T_A = 25 °C		3.4	-2.3	
T_A = 70 °C		2.7	-1.8	
Pulsed drain current	$I_{D\ puls}$	11.6	-7.2	
T_A = 25 °C				
Avalanche energy, single pulse	E_{AS}			mJ
I_D = 2.9 A, V_{DD} = 25 V, R_{GS} = 25 Ω		25	-	
I_D = -1.8 A, V_{DD} = -25 V, R_{GS} = 25 Ω		-	35	
Avalanche energy, periodic limited by T_{jmax}	E_{AR}	0.2	0.2	
Reverse diode d*v*/d*t*, T_{jmax} = 150 °C	d*v*/d*t*			kV/µs
I_S = 2.9 A, V_{DS} = 24 , d*i*/d*t* = 200 A/µs		6	-	
I_S = -1.8 A, V_{DS} = -24 , d*i*/d*t* = -200 A/µs		-	6	
Gate source voltage	V_{GS}	±20	±20	V
Power dissipation	P_{tot}	2	2	W
T_A = 25 °C				
Operating and storage temperature	T_j , T_{stg}	-55...+150		°C
IEC climatic category; DIN IEC 68-1		55/150/56		

Termal Characteristics

Parameter		Symbol	Values			Unit
			min.	typ.	max.	
Dynamic Characteristics						
Thermal resistance, junction - soldering point	N	R_{thJS}	-	-	40	K/W
(Pin 5, 6, 7, 8)	P		-	-	40	
SMD version, device on PCB:		R_{thJA}				
@ min. footprint; t ≤ 10 sec.	N		-	-	100	
@ 6 cm^2 cooling area [1)]; t ≤ 10 sec.	N		-	-	62.5	
@ min. footprint; t ≤ 10 sec.	P		-	-	70	
@ 6 cm^2 cooling area [1)]; t ≤ 10 sec.	P		-	-	62.5	
Static Characteristics, at T_j = 25 °C, unless otherwise specified						
Drain- source breakdown voltage		$V_{(BR)DSS}$				V
V_{GS} = 0 V, I_D = 250 µA	N		30	-	-	
V_{GS} = 0 V, I_D = -250 µA	P		-30	-	-	
Gate threshold voltage, V_{GS} = V_{DS}		$V_{GS(th)}$				
I_D = 20 µA	N		1.2	1.6	2	
I_D = -230 µA	P		-1	-1.5	-2.0	
Zero gate voltage drain current		I_{DSS}				µA
V_{DS} = 30 V, V_{GS} = 0 V, T_j = 25 °C	N		-	0.1	1	
V_{DS} = 30 V, V_{GS} = 0 V, T_j = 125 °C	N		-	10	100	
V_{DS} = -30 V, V_{GS} = 0 V, T_j = 25 °C	P		-	-0.1	-1	
V_{DS} = -30 V, V_{GS} = 0 V, T_j = 125 °C	P		-	-10	-100	
Gate-source leakage current		I_{GSS}				nA
V_{GS} = 20 V, V_{DS} = 0 V	N		-	10	100	
V_{GS} = -20 V, V_{DS} = 0 V	P		-	-10	-100	
Drain-Source on-state resistance		$R_{DS(on)}$				Ω
V_{GS} = 4.5 V, I_D = 2.9 A	N		-	0.1	0.15	
V_{GS} = -4.5 V, I_D = -1.8 A	P		-	0.2	0.4	
Drain-Source on-state resistance		$R_{DS(on)}$				Ω
V_{GS} = 10 V, I_D = 3.4 A	N		-	0.06	0.11	
V_{GS} = -10 V , I_D = -2.3 A	P		-	0.13	0.25	

[1]Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm^2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical without blown air.

Electrical Characteristics, at T_j = 25 °C, unless otherwise specified

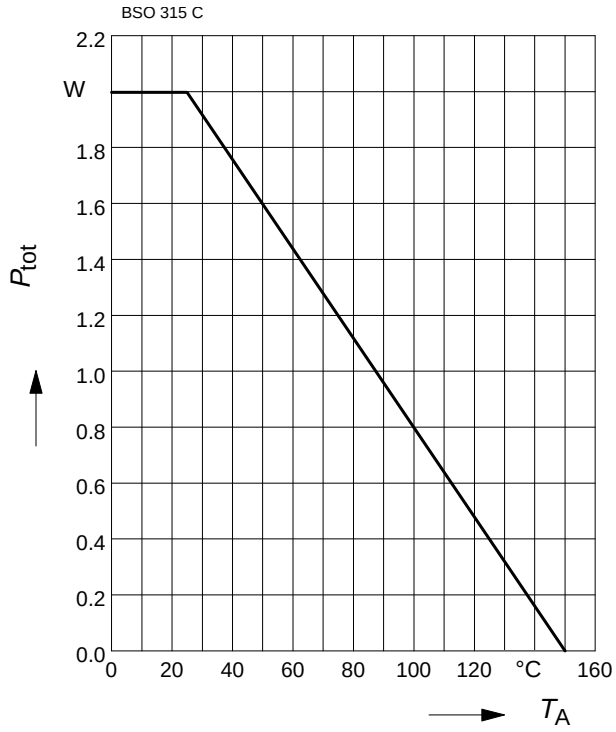
Parameter		Symbol	Values			Unit
			min.	typ.	max.	
Characteristics						
Transconductance		g_{fs}				S
V_{DS}≥2 * I_D * $R_{DS(on)max}$, I_D = 2.9 A	N		2.2	4.5	-	
VV_{DS}≥2 * I_D * $R_{DS(on)max}$, I_D = -1.8 A	P		1.6	3.2	-	
Input capacitance		C_{iss}				pF
V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	N		-	200	250	
V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz	P		-	200	250	
Output capacitance		C_{oss}				
V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	N		-	93	116	
V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz	P		-	113	140	
Reverse transfer capacitance		C_{rss}				
V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	N		-	50	63	
V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz	P		-	38	48	
Turn-on delay time		$t_{d(on)}$				ns
V_{DD} = 15 V, V_{GS} = 4.5 V, I_D = 2.9 A, R_G = 33 Ω	N		-	15	22	
V_{DD} = -15 V, V_{GS} = -4.5 V, I_D = -1.8 A, R_G = 24 Ω	P		-	22	33	
Rise time		t_r				
V_{DD} = 15 V, V_{GS} = 4.5 V, I_D = 2.9 A, R_G = 33 Ω	N		-	96	144	
V_{DD} = -15 V, V_{GS} = -4.5 V, I_D = -1.8 A, R_G = 24 Ω	P		-	71	107	
Turn-off delay time		$t_{d(off)}$				
V_{DD} = 15 V, V_{GS} = 4.5 V, I_D = 2.9 A, R_G = 33 Ω	N		-	13	20	
V_{DD} = -15 V, V_{GS} = -4.5 V, I_D = -1.8 A, R_G = 24 Ω	P		-	56	84	
Fall time		t_f				
V_{DD} = 15 V, V_{GS} = 4.5 V, I_D = 2.9 A, R_G = 33 Ω	N		-	20	30	
V_{DD} = -15 V, V_{GS} = -4.5 V, I_D = -1.8 A, R_G = 24 Ω	P		-	61	90	

Electrical Characteristics, at T_j = 25 °C, unless otherwise specified

Parameter		Symbol	Values			Unit
			min.	typ.	max.	
Characteristics						
Gate to source charge		Q_{gs}				nC
V_{DD} = 24 V, I_D = 3.4 A	N		-	1.1	1.6	
V_{DD} = -24 V, I_D = -2.3 A	P		-	1.1	1.6	
Gate to drain charge		Q_{gd}				
V_{DD} = 24 V, I_D = 3.4 A	N		-	3.3	5	
V_{DD} = -24 V, I_D = -2.3 A	P		-	2.1	3.2	
Gate charge total		Q_g				
V_{DD} = 24 V, I_D = 3.4 A, V_{GS} = 0 to 10V	N		-	7.8	11.7	
V_{DD} = -24 V, I_D = -2.3 A, V_{GS} = 0 to -10V	P		-	7	10	
Gate plateau voltage		$V_{(plateau)}$				V
V_{DD} = 24 V, I_D = 3.4 A	N		-	3.5	-	
V_{DD} = -24 V, I_D = -2.3 A	P		-	-2.8	-	
Reverse Diode						
Inverse diode continuous forward current	N	I_S	-	-	2.9	A
T_A = 25 °C	P		-	-	-1.8	
Inverse diode direct current,pulsed	N	I_{SM}	-	-	11.6	
T_A = 25 °C	P		-	-	-7.2	
Inverse diode forward voltage		V_{SD}				V
V_{GS} = 0 V, I_F = I_S	N		-	0.85	1.1	
V_{GS} = 0 V, I_F = I_S	P		-	-0.85	-1.1	
Reverse recovery time		t_{rr}				ns
V_R = 15 V, I_F=I_S, di_F/dt = 100 A/µs	N		-	25	38	
V_R = -15 V, I_F=I_S , di_F/dt = -100 A/µs	P		-	60	90	
Reverse recovery charge		Q_{rr}				µC
V_R = 15 V, I_F=I_S , di_F/dt = 100 A/µs	N		-	12	18	
V_R = -15 V, I_F=I_S, di_F/dt = -100 A/µs	P		-	37	55	

Power Dissipation (N-Ch.)

$P_{tot} = f(T_A)$



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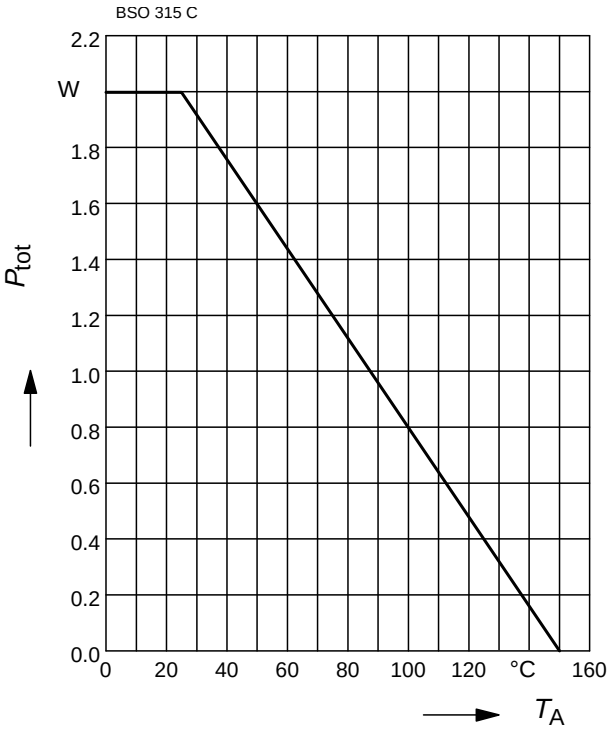
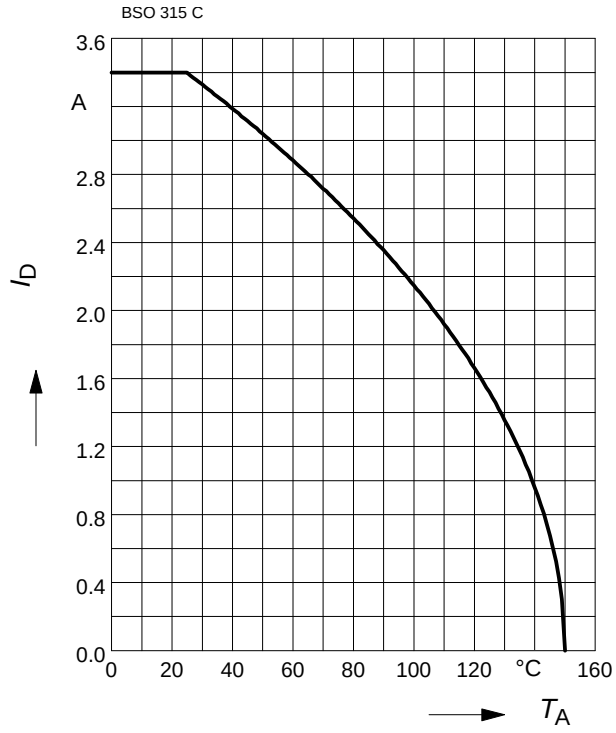
$P_{tot} = f(T_A)$



Drain current (N-Ch.)

$I_D = f(T_A)$

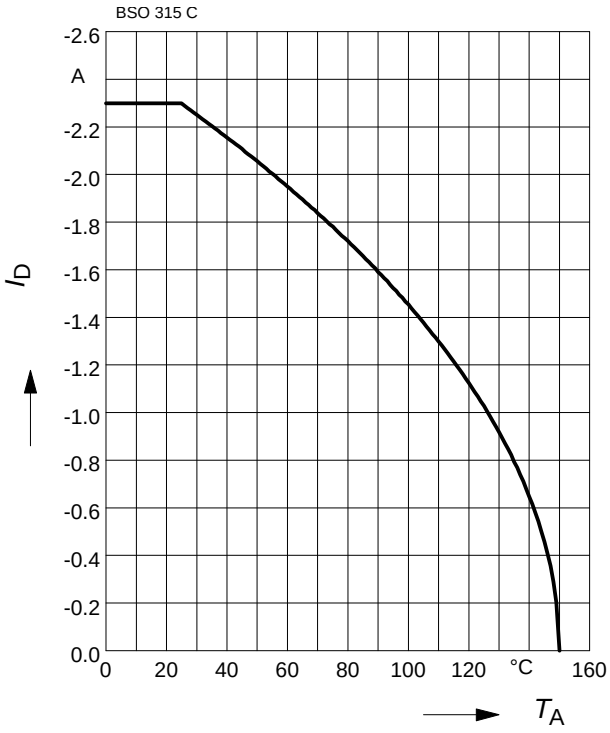
parameter: $V_{GS} \geq 10$ V



Drain current (P-Ch.)

$I_D = f(T_A)$

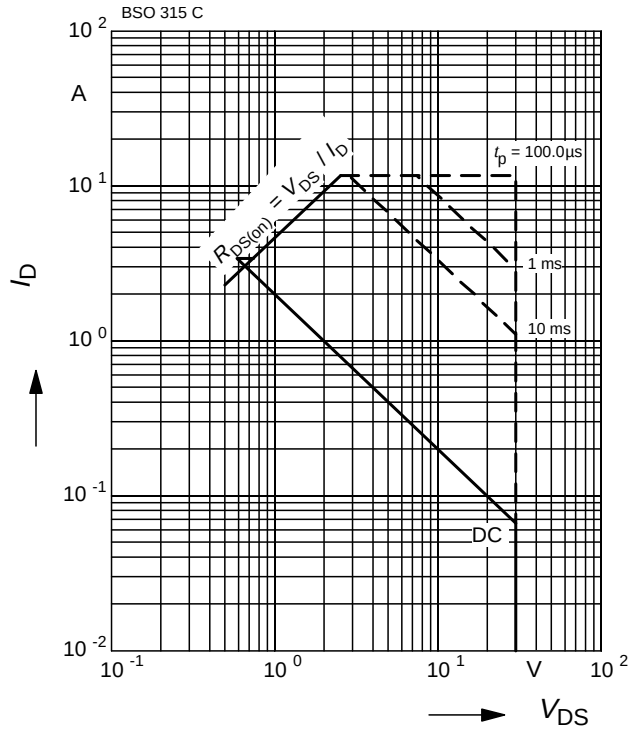
parameter: $V_{GS} \geq -10$ V



Safe operating area (N-Ch.)

$I_D = f(V_{DS})$

parameter : $D = 0$, $T_A = 25$ °C



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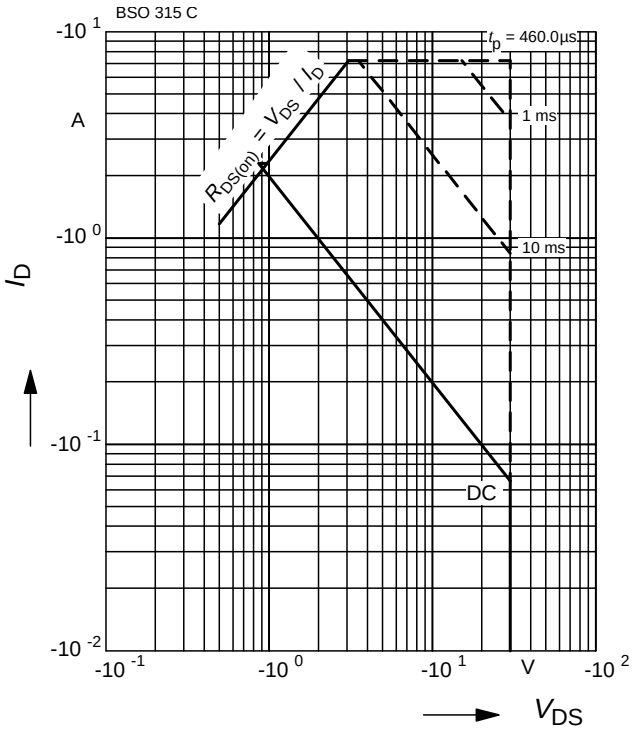
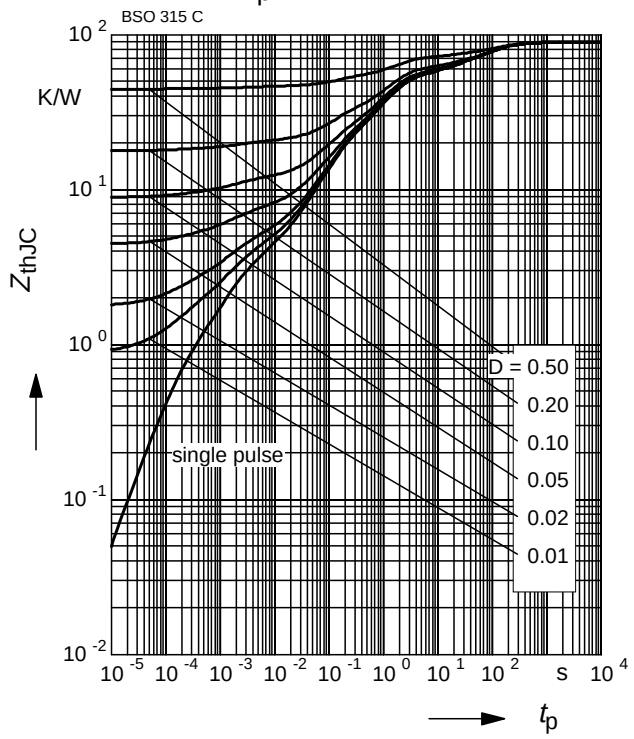


Transient thermal impedance (N-Ch.)

$Z_{thJC} = f(t_p)$

parameter : $D = t_p/T$



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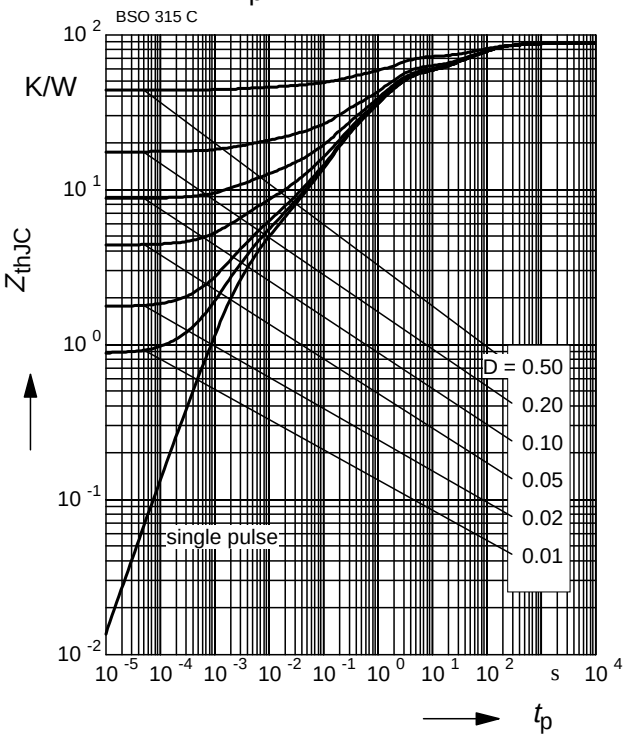
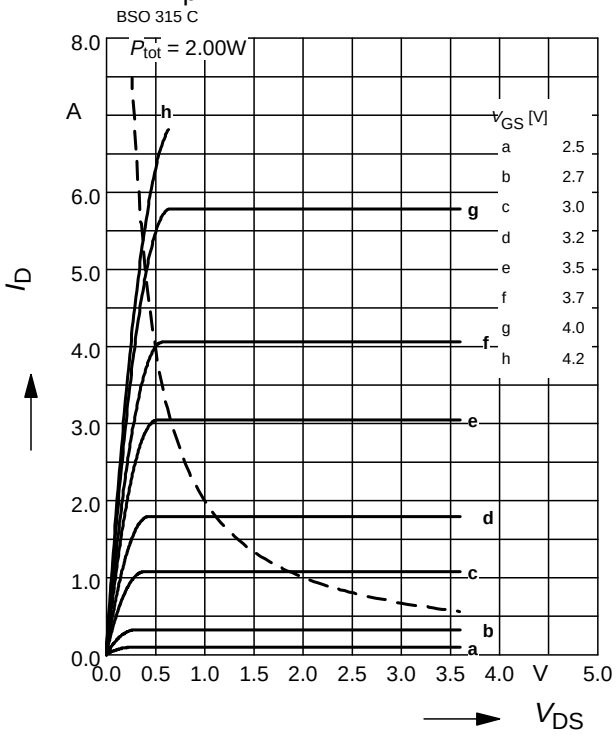


Typ. output characteristics (N-Ch.)

$I_D = f(V_{DS})$

parameter: t_p = 80 µs



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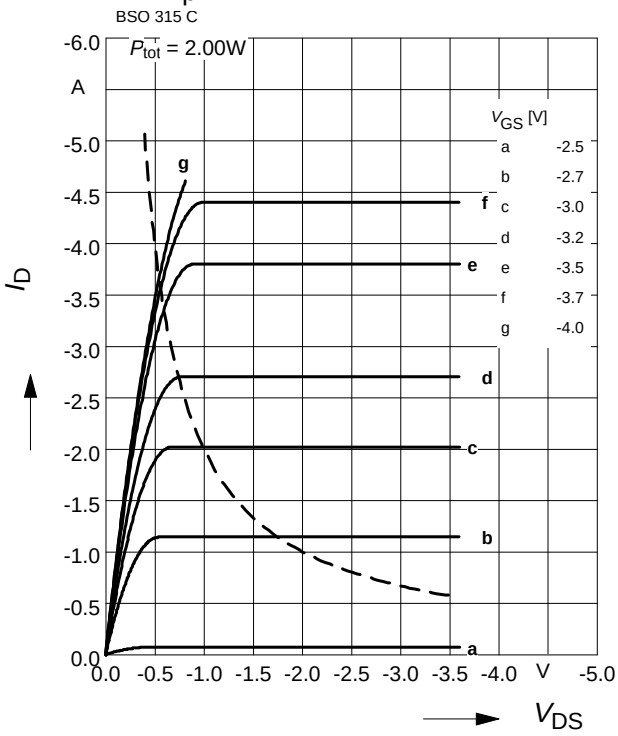
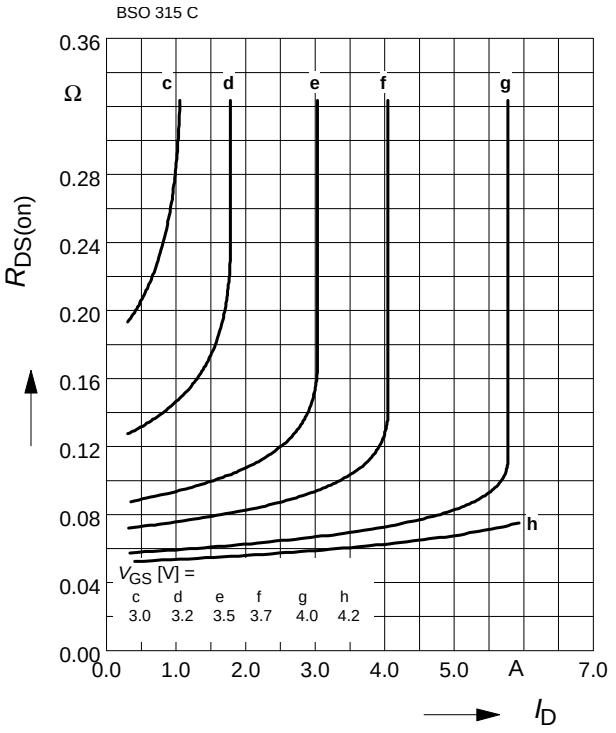


Typ. drain-source-on-resistance (N-Ch.)

$R_{DS(on)} = f(I_D)$

parameter: V_{GS}



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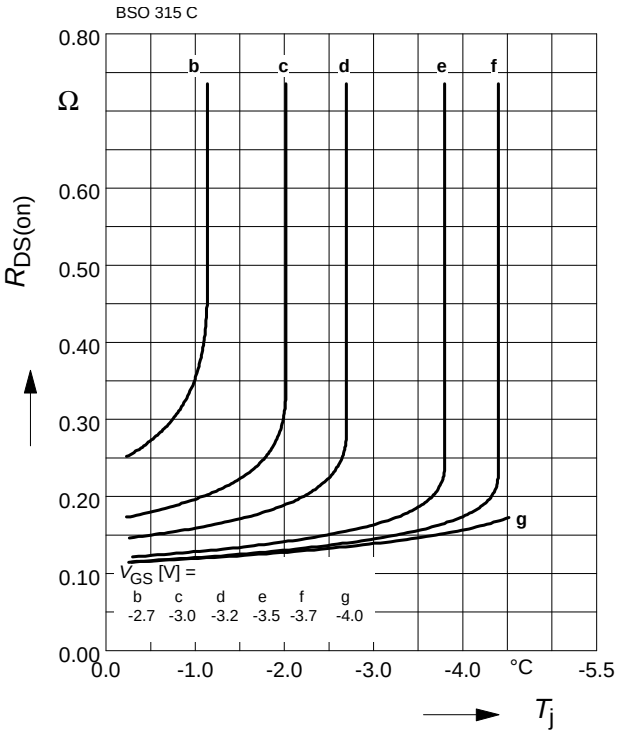
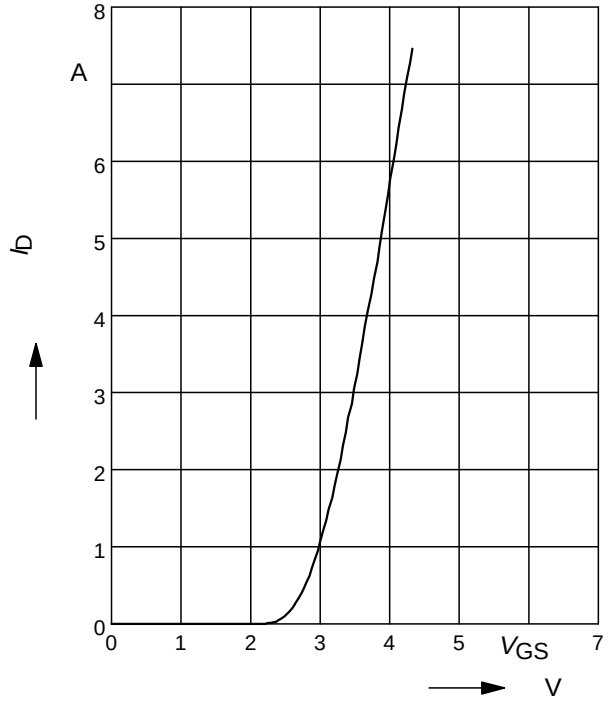


Typ. transfer characteristics (N-Ch.)

parameter: t_p = 80 µs

$I_D = f(V_{GS})$, $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$



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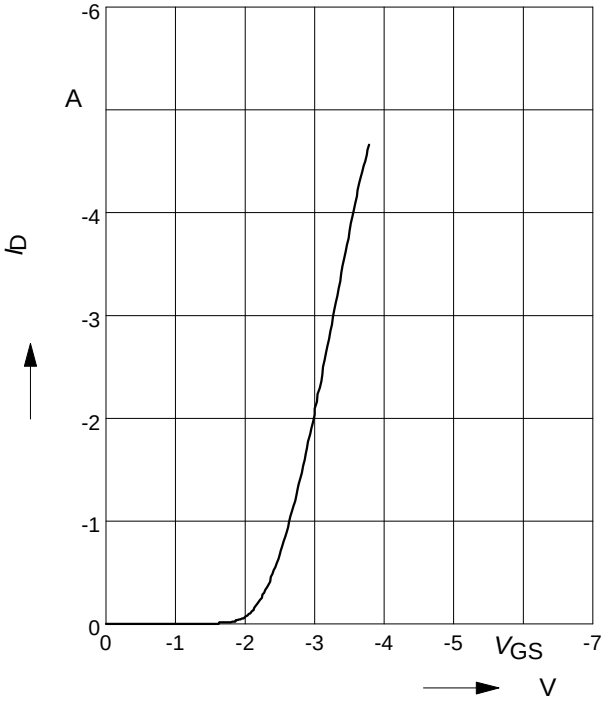
parameter: t_p = 80 µs

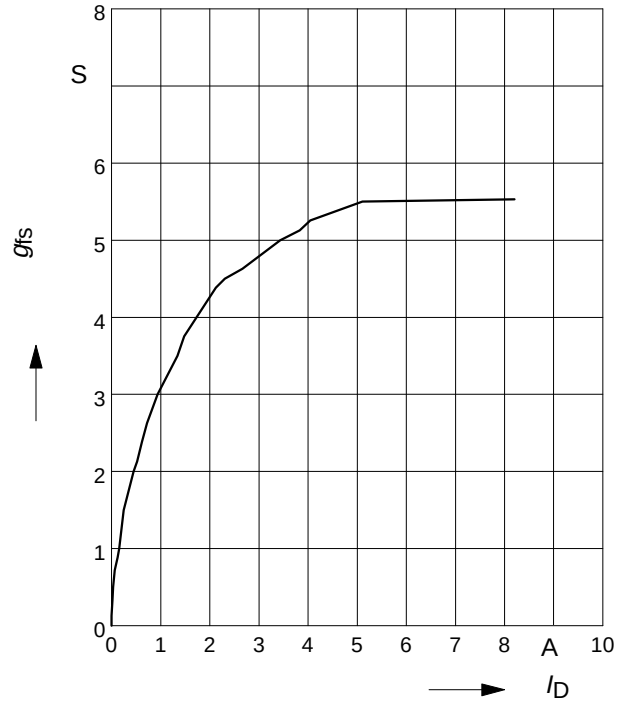
$I_D = f(V_{GS})$, $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$



Typ. forward transconductance (N-Ch.)

g_{fs} = f(I_D); T_j = 25 °C

parameter: g_{fs}



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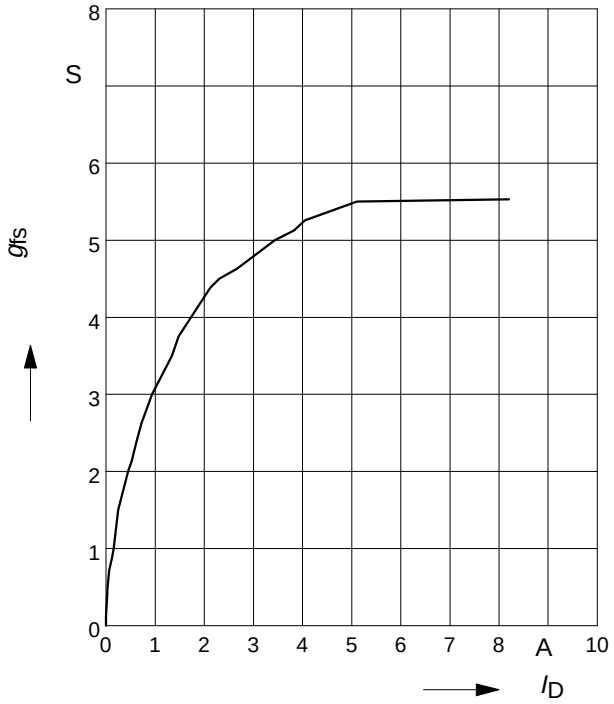
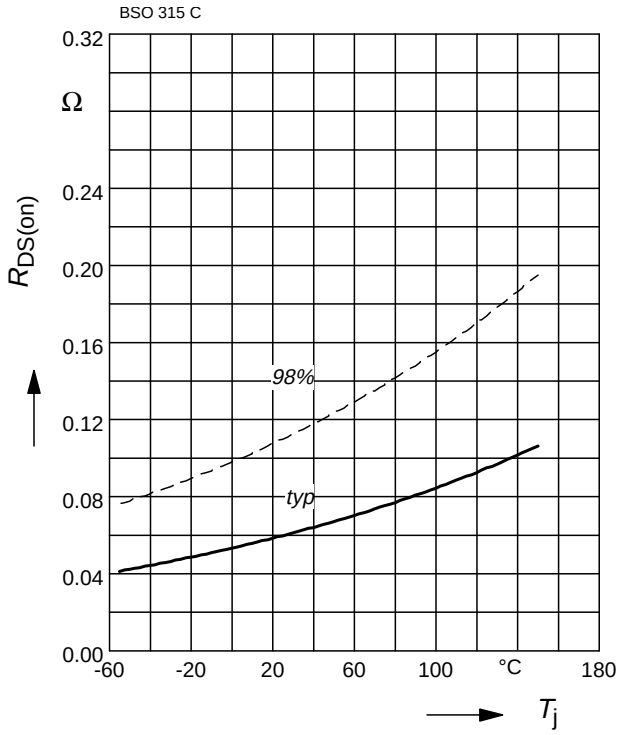
parameter: g_{fs}



Drain-source on-resistance (N-Ch.)

$R_{DS(on)} = f(T_j)$

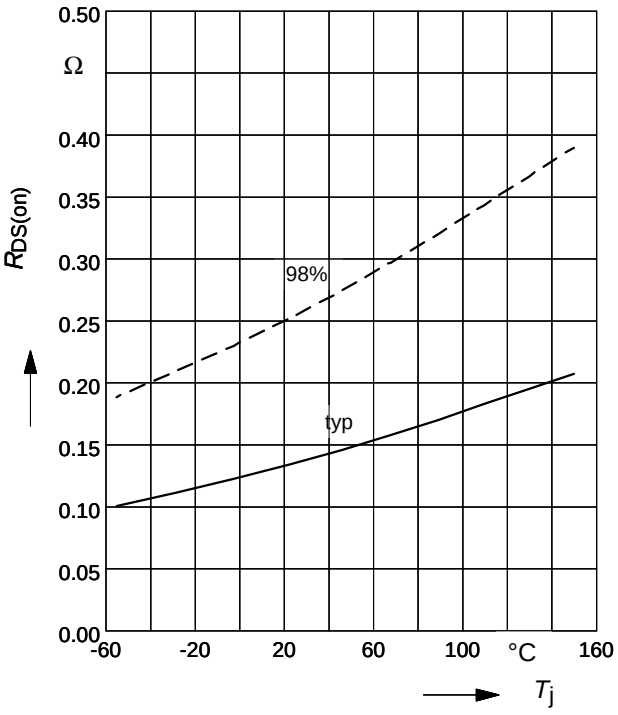
parameter : I_D = 3.4 A, V_{GS} = 10 V



Drain-source on-resistance (P-Ch.)

$R_{DS(on)} = f(T_j)$

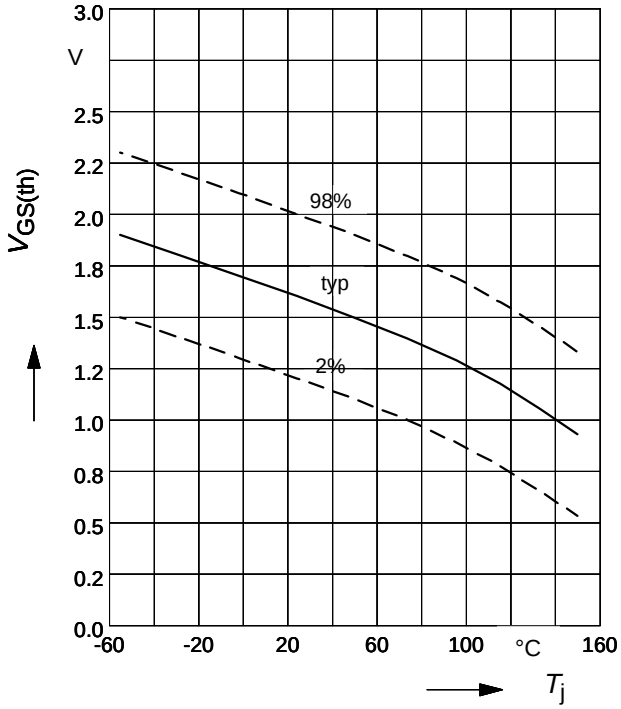
Parameter: I_D = -2.3 A, V_{GS} = -10 V



Gate threshold voltage (N-Ch.)

$V_{GS(th)} = f(T_j)$

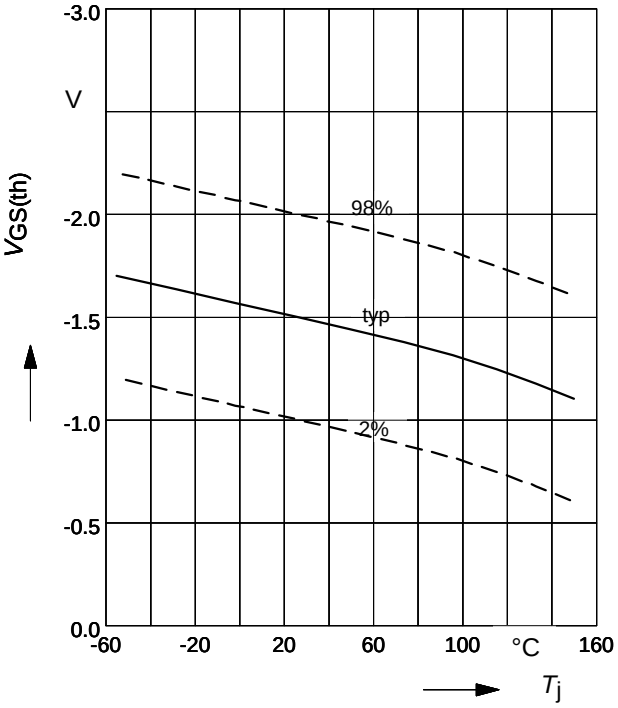
parameter: $V_{GS} = V_{DS}$, I_D = 20 µA



Gate threshold voltage (P-Ch.)

$V_{GS(th)} = f(T_j)$

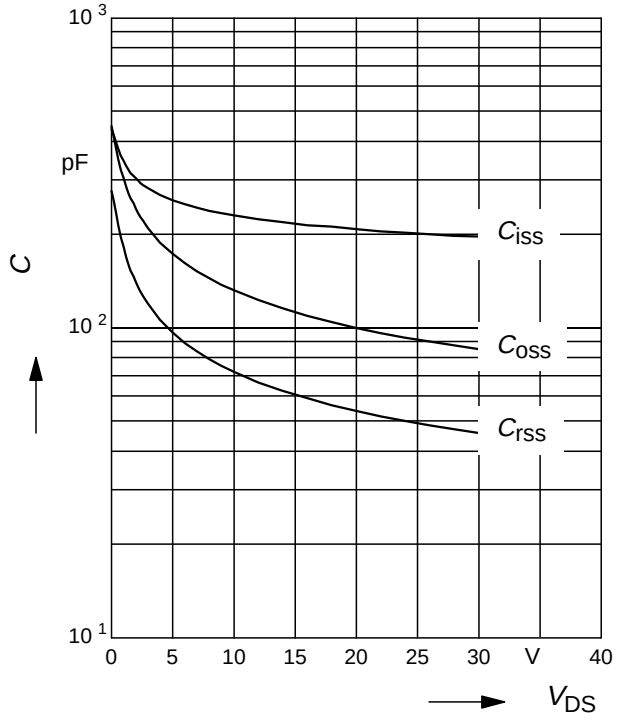
parameter: $V_{GS} = V_{DS}$, I_D = -230 µA



Typ. capacitances (N-Ch.)

$C = f(V_{DS})$

parameter: V_{GS}=0 V, f=1 MHz



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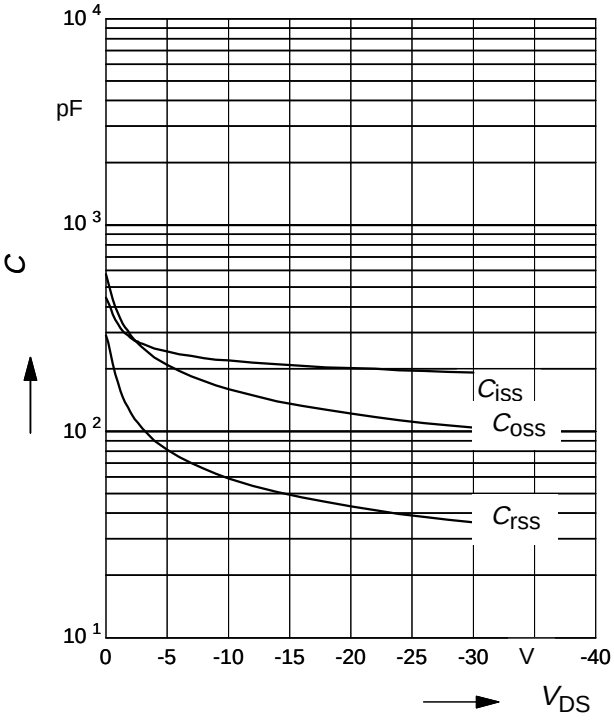
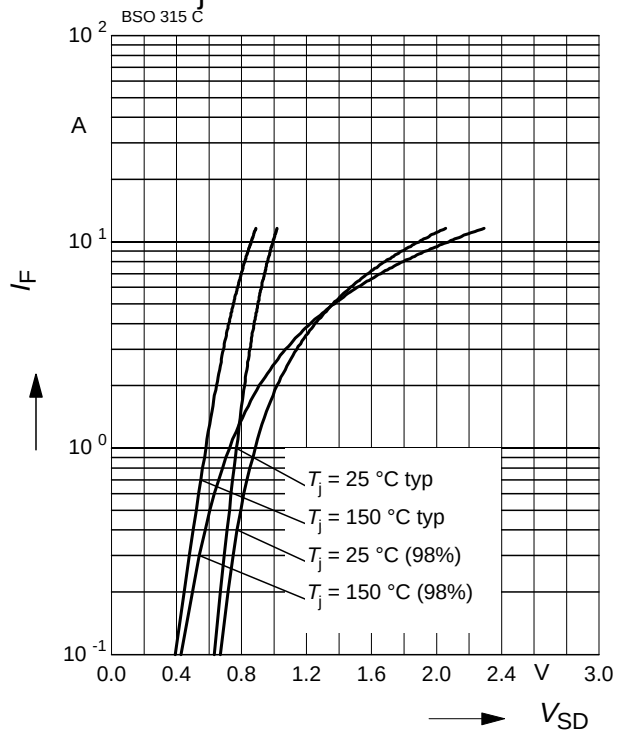
parameter: V_{GS}=0 V, f=1 MHz



Forward characteristics of reverse diode

$I_F = f(V_{SD})$, (N-Ch.)

parameter: T_j , tp = 80 µs



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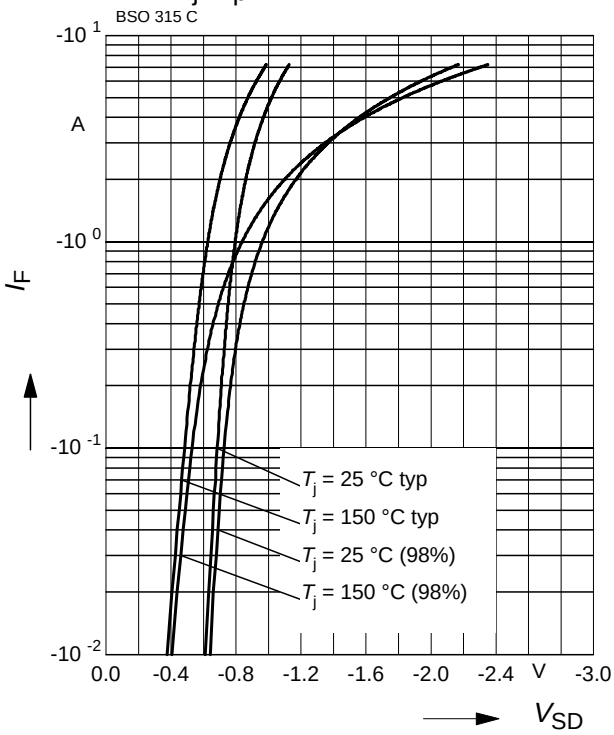
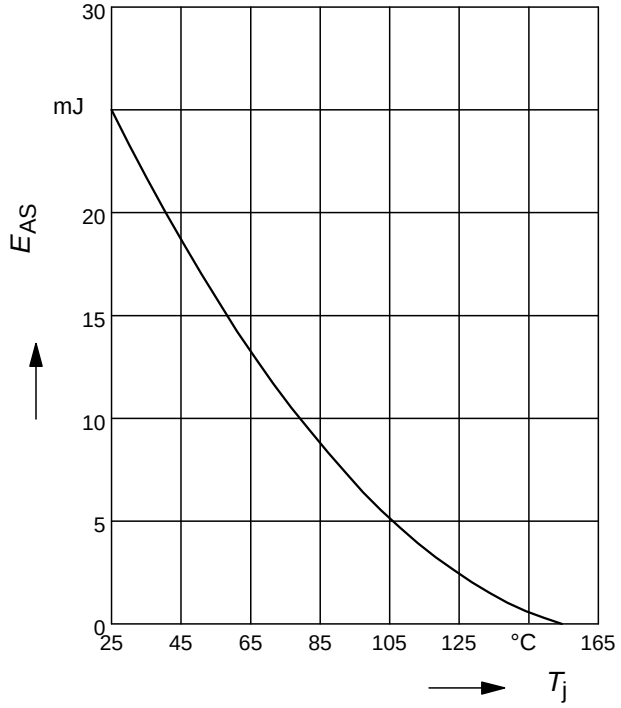


Avalanche Energy $E_{AS} = f(T_j)$ (N-Ch.)

parameter: I_D = 2.9 A, V_{DD} = 25 V

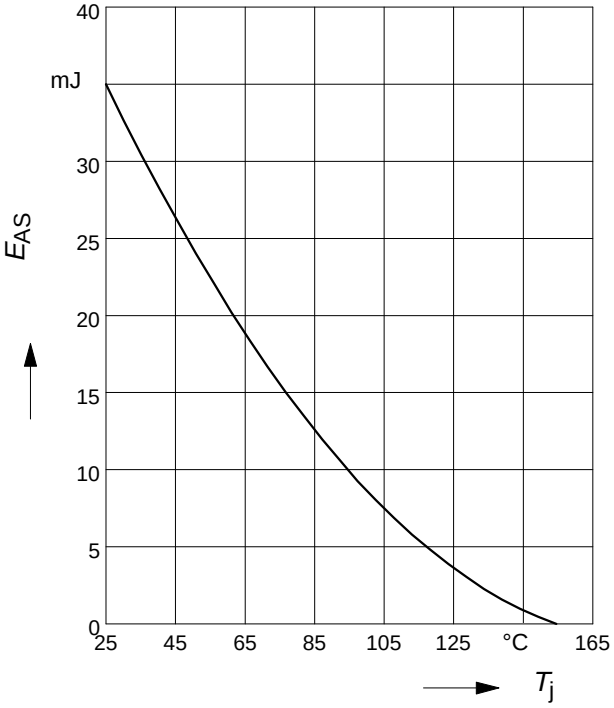
R_{GS} = 25 Ω



Avalanche Energy $E_{AS} = f(T_j)$

parameter: I_D = -1.8 A, V_{DD} = -25 V

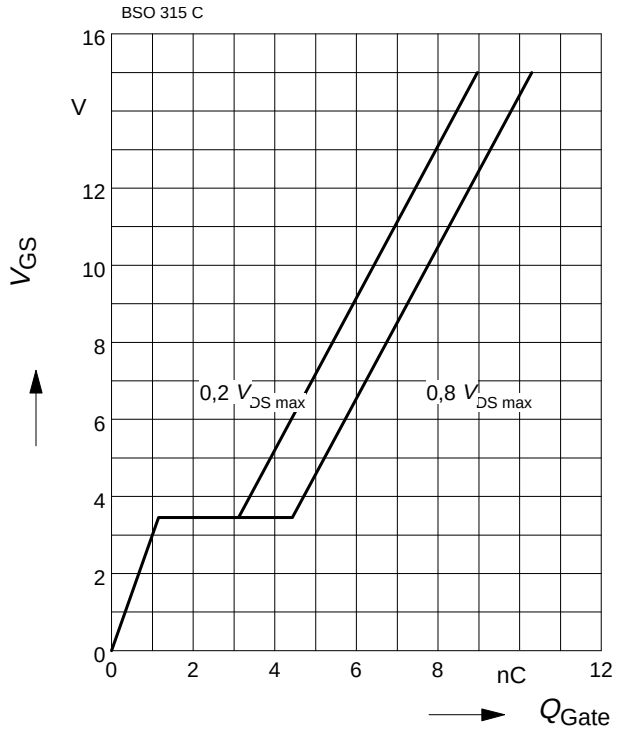
R_{GS} = 25 Ω



Typ. gate charge (N-Ch.)

V_{GS} = f (Q_{Gate})

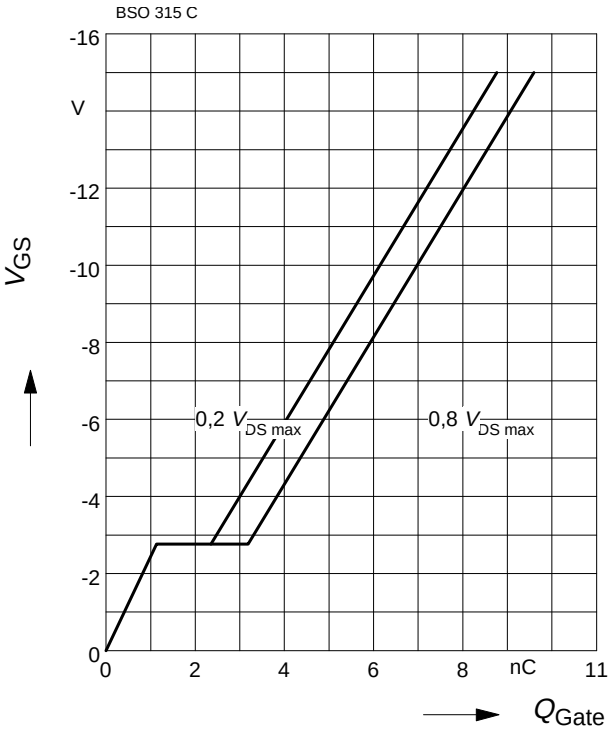
parameter: I_D = 3.4 A



Typ. gate charge (P-Ch.)

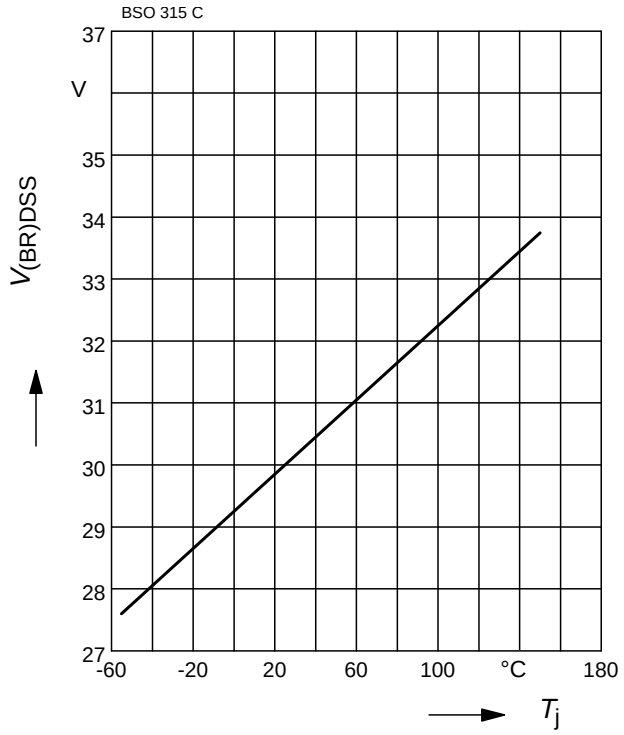
V_{GS} = f (Q_{Gate})

parameter: I_D = -2.3 A



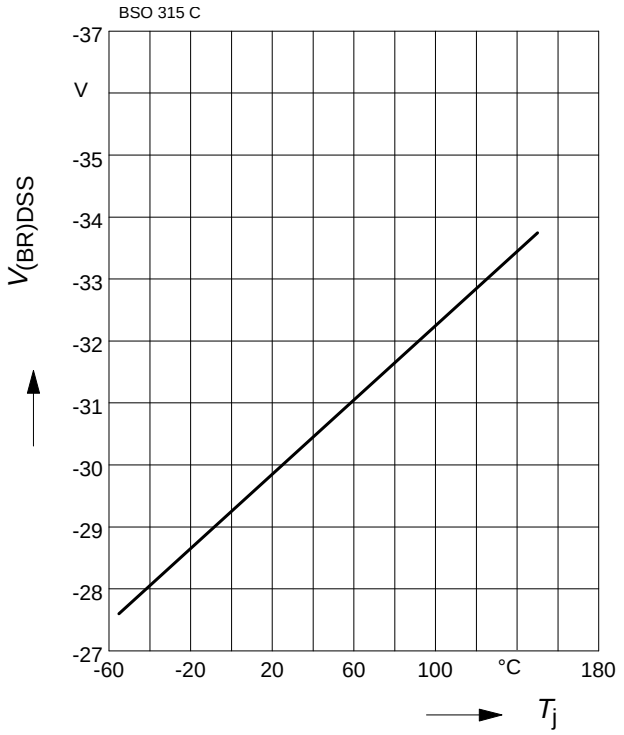
Drain-source breakdown voltage

$V_{(BR)DSS}$ = f (T_j), (N-Ch.)



Drain-source breakdown voltage

$V_{(BR)DSS}$ = f (T_j), (P-Ch.)



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